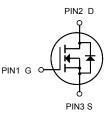


General Description

The high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition, this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes. The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power suppliers, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.



TO-220



FEATURES

- Robust High Voltage Termination
- Avalanche Energy Specified
- Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- Diode is Characterized for Use in Bridge Circuits
- I_{DSS} and V_{DS(on)} Specified at Elevated Temperature

Maximum ratings (T_a=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit	
Drain-Source Voltage	V _{DS} 600		V	
Gate-Source Voltage	V _{GS}	±20	V	
Continuous Drain Current	ID	2	— A	
Pulsed Drain Current	I _{DM}	8		
Power Dissipation	PD	2	W	
Single Pulsed Avalanche Energy*	E _{AS}	128	mJ	
Thermal Resistance, Junction-to-Ambient	R _{θJA}	62.5	°C/W	
Junction Temperature	TJ	150	<u></u>	
Storage Temperature	Тѕтс	-50 ~+150		

*E_{AS} condition: $T_j=25^{\circ}C$, $V_{DD}=50V$, L=64mH, $I_{AS}=2A$, $R_G=25\Omega$



Shenzhen yecheng technology industry co., ltd

N-Channel Power MOSFET

Electrical characteristics (T_a=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	V(BR)DSS	V _{GS} = 0V, I _D =250µA V _{DS} =V _{GS} , I _D =250µA	600			V
Gate-Threshold Voltage (note1)	VGS(th)		2.0		4.0	
Gate-Body Leakage Current (note1)	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =600V, V _{GS} =0V			25	μA
Drain-Source On-State Resistance (note1)	RDS(on)	Vgs =10V, Id =1A			4.4	Ω
Forward Transconductance (note1)	g _{FS}	VDS =50V, ID =1A	1			S
Input Capacitance (note 2)	C _{iss}	V _{DS} =25V,V _{GS} =0V, f =1MHz		435		pF
Output Capacitance (note 2)	C _{oss}			56		
Reverse Transfer Capacitance (note 2)	C _{rss}			9.2		
Turn-On Delay Time (note 2)	t _{d(on)}	V _{DD} =300V,I _D =2A, V _{GS} =10V,R _G =18Ω		12		ns
Rise Time (note 2)	tr			21		
Turn-Off Delay Time (note 2)	td(off)			30		
Fall Time (note 2)	tr			24		
Forward on Voltage(note1)	V _{SD}	V _{GS} =0V, I _S =2A			1.6	V

Notes:

1. Pulse Test : Pulse width \leq 300µs, duty cycle \leq 2%.

2. These parameters have no way to verify.